

Ite	ms	Specifications		
Rating (max.)/(mi (Resistive load)	n.)	0.1A 30V DC / 50 μA 3V DC		
Contact resistand (Initial / After ope	-	500mΩ max. / 1Ω max.		
Operating force		0.3N max.		
Operating life	Without load	50,000cycles		
Operating life	With load	50,000cycles (0.1A 30V DC)		

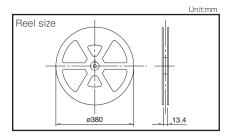
# Product Line

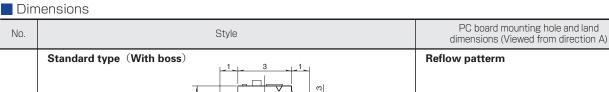
Poles	Positions	Terminal type	Slider height (mm)	ON start position (mm)	Total travel position (mm)	Style	Location lug	Minimumord Japan	er unit (pcs) Export	Product No.	Drawing No.
			h=2.0	h <sub>1</sub> =3.5	h₂=2.5		Without			SPVE110100	
			h=3.8	N₁=3.5			With	0.000	00.400	SPVE110600	
			h=4.1	h <sub>1</sub> =3.8	h <sub>2</sub> =2.9		Without	2,800	22,400	SPVE110401	
			11—4.1	111-0.0	112-2.9	Standard	With			SPVE110801	1
1	1	For PC board (Reflow) h=4		h <sub>1</sub> =4.5	h₂=3.6		Without	2,200	17.600	SPVE110200	'
							2,200	17,000	SPVE110900		
			h=5.2 h <sub>1</sub> =4.9 h <sub>2</sub> =4.0 h=5.5 h <sub>1</sub> =5.2 h <sub>2</sub> =4.3		h=5.2 h₁=4.9 h₂=4.0 With	With	2,000	16.000	SPVE111300		
				h <sub>2</sub> =4.3				10,000	SPVE111200		
			3.3	3.0	2.0	Low-profile	_	2,800	22,400	SPVE210100	2

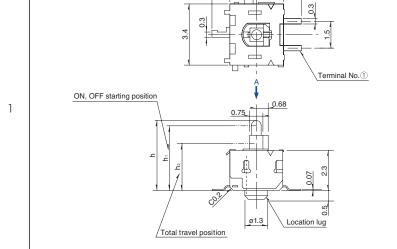
# Packing Specifications

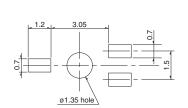
#### Taping

Product No.	Numbe	er of packages	Tape width	Export package measurements (mm)		
T TOUGET NO.	1 reel	1 reel 1 case /Japan 1 case /export packing				(mm)
SPVE110100 SPVE110600 SPVE110401 SPVE110801	2,800	5,600	22,400			
SPVE110200 SPVE110900	2,200	4,400	17,600	12	406×406×190	
SPVE111300 SPVE111200	2,000	4,000	16,000			
SPVE210100	2,800	5,600	22,400			

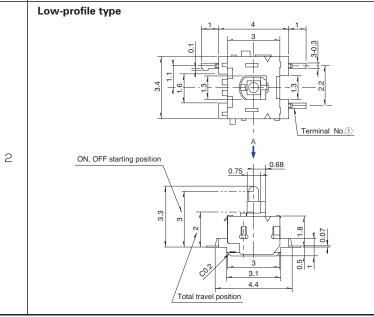


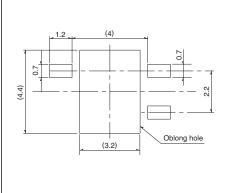






Unit:mm





#### Note

Dimensions drawing is for type with location lugs.

# Terminal Layout (Viewed from Direction A)

Standard type	Low-profile type
3	3-2-1

# Circuit Diagram

Standard type	Low-profile type
3—————————————————————————————————————	

Series				General-pu	rpose Type	,	
		SPVS	SPVN	SPVT	SPVM	SPVR	SPVE
I	Photo			A Sept			
Operation type			Two-way				One-way
	W	3.5	3.8	5.6	2.8	3.6	3.4
Dimensio (mm)	ins D	3.3	3.6	4.7	3.5	4.2	3
(11111)	Н		1	1.9	1.5	1.2	2.3
Operating to	emperature range			−40°C to +85°C			-10℃ to +60℃
Autor	notive use	•	•	•	•	•	_
Life cycl	e (availability)	*3	*3	*3	*3	*3	<b>*</b> 3
Poles	/ Positions			1	/1		
Rating (max.) (Resistive load)		1mA 5V DC		50mA 20V DC	1mA 5V DC		0.1A 30V DC
Rating (min.) (Resistive load)		50μA 3V DC		100μA 3V DC	50μA 3V DC	100μA 3V DC	50μA 3V DC
	Operating life without load	50,000cycles 5Ω max.		100,000cycles 1Ω max.	$50,000$ cycles $5\Omega$ max.		50,000cycles 1Ω max.
Durability	Operating life with load Rating (max.) (Resistive load)	50,000cycles 5Ω max.		100,000cycles 1Ω max.	$50,000$ cycles $5\Omega$ max.		50,000cycles 1Ω max.
	Initial contact resistance	2Ω max.		500mΩ max.	2Ω max.	3Ω max.	500mΩ max.
Electrical performance	Insulation resistance			100MΩ mi			
	Voltage proof	100V AC for 1 minute					
Mechanical	Terminal strength		0.5N for 1minute		1N for 1minute	0.5N fo	r 1minute
performance	Actuator strength	5N		10N	5N 2N		5N
	Cold			-40℃ 96h			-20°C 96h
Environmental performance	Dry heat						
	Damp heat						
Opera	ation force	0.35	N max.	0.4N	0.4N max. 0.35N n		0.3N max.
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Note

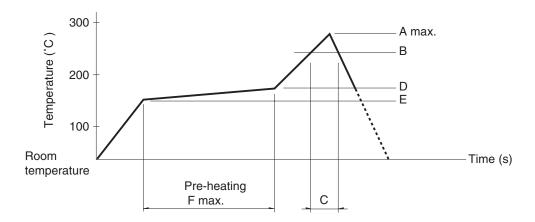
Indicates applicability to all products in the series.

## Example of Reflow Soldering Condition

- 1. Heating method: Double heating method with infrared heater. 
  2. Temperature measurement: Thermocouple  $\phi$ 0.1 to 0.2 CA (K) or CC (T) at soldering portion (copper foil surface). 
  A heat resisting tape should be used for fixed measurement.

**Detector Switches Soldering Conditions** 

3. Temperature profile



Series (Reflow type)	A (℃) 3s max.	B (℃)	C (s)	D (℃)	E (℃)	F(s)
SPPB	250		40			
SPPW8	250	230	35	180	150	120
SPVE			40			
SPVL						
SPVM						
SPVN	260					
SPVR						
SPVS						
SPVT						
SSCM						
SSCQ						
SPVQC, SPVQE	250					

- 1. The condition mentioned above is the temperature on the mounting surface of a PC board. There are cases where the PC board's temperature greatly differs from that of the switch, surface depending on the PC board's material, size, thickness, etc. The above-stated conditions shall also apply to switch surface temperatures.
- 2. Soldering conditions differ depending on reflow soldering machines. Prior verification of soldering condition is highly recommended.

## Reference for Hand Soldering

Series	Soldering temperature	Soldering time	
SPVS, SPVN, SPVT, SPVM, SPVR, SPVE, SPPW8,SSCQ, SSCM, SPVL, SSCT, SPVQC, SPVQE	350±5℃	3s max.	
SPVQ1, SPVQ3, SPVQ6, SPVQ7, SPVQ8, SPVQ9, SSCN, SPVQA	300±10℃	3+1/0s	
SPPB (Reflow)	300±5℃	5s max.	
SSCF, SPPB (For Lead, Dip)	350±10℃	3+1/0s	

# Reference for Dip Soldering (For PC board terminal types)

	Ite	ms	Dip soldering		
Series	Preheating temperature	Preheating time	Soldering temperature	Duration of immersion	
SSCT, SPVQ1, SPVQ3, SPVQ6, SPVQ7, SPVQ8, SPVQ9, SPVQA	100±10℃	60s max.	260±5℃	5±1s	
SPPW8, SPPB	100 ℃ max.	60s max.	255±5℃	5±1s	
SSCF	_		260±5℃	5±1s	

